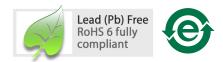
ASMT-UWB1-Nxxxx

OneWhite Surface Mount PLCC-2 LED Indicator



Data Sheet





Description

This family of SMT LEDs is packaged in the industry standard PLCC-2 package. These SMT LEDs have high reliability performance and are designed to work under a wide range of environmental conditions. This high reliability feature makes them ideally suited to be used as interior signs application conditions.

To facilitate easy pick & place assembly, the LEDs are packed in EIA-compliant tape and reel. Every reel will be shipped in single intensity and color bin.

These LEDs are compatible with reflow soldering process.

The wide viewing angle at 120° makes these LEDs ideally suited for panel, push button, office equipment, industrial equipment, and home appliances. The flat top emitting surface makes it easy for these LEDs to mate with light pipes. With the built-in reflector pushing up the intensity of the light output, these LEDs are also suitable to be used as LED pixels in interior electronic signs.

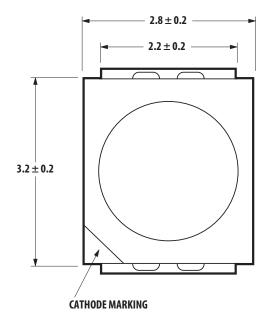
Features

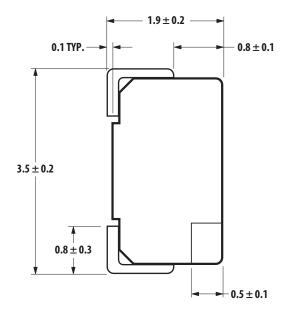
- High reliability package with silicone encapsulation
- Compatible with reflow soldering process
- High optical efficiency with 100 lm/W
- Available in 8 mm carrier tape with reel diameter 180mm
- JEDEC MSL 3 product
- ESD threshold of 1000 V (HBM model) per Jedec

Applications

- Non-automotive use
- General Signage backlighting
- Amusement machine backlighting
- Industrial lighting
- Light strips

Package Drawing





Notes:

- 1. All dimensions in millimeters.
- 2. Terminal finish = Ag plating.

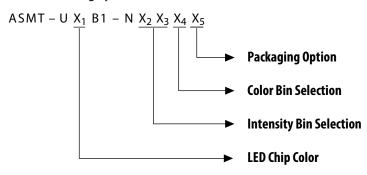
Device Selection Guide

	ССТ	Luminous Intensity (mcd) [1,2]			Test Current		
Part Number	(K)	Min	Тур	Max	(mA)	Chip	
ASMT-UWB1-NX302	4500 ~ 8000	1800	2300	3550	20	InGaN	
ASMT-UWB1-NX312	2700 ~ 4000	1800	2300	3550	20	InGaN	
ASMT-UWB1-NX3A2	8000	1800	2300	3550	20	InGaN	
ASMT-UWB1-NX3B2	6500	1800	2300	3550	20	InGaN	
ASMT-UWB1-NX3C2	5700	1800	2300	3550	20	InGaN	
ASMT-UWB1-NX3D2	5000	1800	2300	3550	20	InGaN	
ASMT-UWB1-NX3E2	4500	1800	2300	3550	20	InGaN	
ASMT-UWB1-NX3F2	4000	1800	2300	3550	20	InGaN	
ASMT-UWB1-NX3G2	3500	1800	2300	3550	20	InGaN	
ASMT-UWB1-NX3H2	3000	1800	2300	3550	20	InGaN	
ASMT-UWB1-NX3J2	2700	1800	2300	3550	20	InGaN	
ASMT-UWB1-NX7B2	6500	2240	-	4500	20	InGaN	
ASMT-UWB1-NX7D2	5000	2240	-	4500	20	InGaN	
ASMT-UWB1-NX7C2	5700	2240	-	4500	20	InGaN	
	ASMT-UWB1-NX302 ASMT-UWB1-NX312 ASMT-UWB1-NX3A2 ASMT-UWB1-NX3B2 ASMT-UWB1-NX3C2 ASMT-UWB1-NX3D2 ASMT-UWB1-NX3E2 ASMT-UWB1-NX3F2 ASMT-UWB1-NX3F2 ASMT-UWB1-NX3H2 ASMT-UWB1-NX3H2 ASMT-UWB1-NX3H2 ASMT-UWB1-NX7D2	Part Number (K) ASMT-UWB1-NX302 4500 ~ 8000 ASMT-UWB1-NX312 2700 ~ 4000 ASMT-UWB1-NX3A2 8000 ASMT-UWB1-NX3B2 6500 ASMT-UWB1-NX3C2 5700 ASMT-UWB1-NX3D2 5000 ASMT-UWB1-NX3E2 4500 ASMT-UWB1-NX3F2 4000 ASMT-UWB1-NX3G2 3500 ASMT-UWB1-NX3H2 3000 ASMT-UWB1-NX3J2 2700 ASMT-UWB1-NX7B2 6500 ASMT-UWB1-NX7D2 5000	Part Number (K) Min ASMT-UWB1-NX302 4500 ~ 8000 1800 ASMT-UWB1-NX312 2700 ~ 4000 1800 ASMT-UWB1-NX3A2 8000 1800 ASMT-UWB1-NX3B2 6500 1800 ASMT-UWB1-NX3C2 5700 1800 ASMT-UWB1-NX3D2 5000 1800 ASMT-UWB1-NX3E2 4500 1800 ASMT-UWB1-NX3F2 4000 1800 ASMT-UWB1-NX3G2 3500 1800 ASMT-UWB1-NX3H2 3000 1800 ASMT-UWB1-NX3J2 2700 1800 ASMT-UWB1-NX7B2 6500 2240 ASMT-UWB1-NX7D2 5000 2240	Part Number (K) Min Typ ASMT-UWB1-NX302 4500 ~ 8000 1800 2300 ASMT-UWB1-NX312 2700 ~ 4000 1800 2300 ASMT-UWB1-NX3A2 8000 1800 2300 ASMT-UWB1-NX3B2 6500 1800 2300 ASMT-UWB1-NX3C2 5700 1800 2300 ASMT-UWB1-NX3D2 5000 1800 2300 ASMT-UWB1-NX3E2 4500 1800 2300 ASMT-UWB1-NX3F2 4000 1800 2300 ASMT-UWB1-NX3G2 3500 1800 2300 ASMT-UWB1-NX3H2 3000 1800 2300 ASMT-UWB1-NX3J2 2700 1800 2300 ASMT-UWB1-NX7B2 6500 2240 - ASMT-UWB1-NX7D2 5000 2240 -	Part Number (K) Min Typ Max ASMT-UWB1-NX302 4500 ~ 8000 1800 2300 3550 ASMT-UWB1-NX312 2700 ~ 4000 1800 2300 3550 ASMT-UWB1-NX3A2 8000 1800 2300 3550 ASMT-UWB1-NX3B2 6500 1800 2300 3550 ASMT-UWB1-NX3C2 5700 1800 2300 3550 ASMT-UWB1-NX3D2 5000 1800 2300 3550 ASMT-UWB1-NX3E2 4500 1800 2300 3550 ASMT-UWB1-NX3F2 4000 1800 2300 3550 ASMT-UWB1-NX3G2 3500 1800 2300 3550 ASMT-UWB1-NX3H2 3000 1800 2300 3550 ASMT-UWB1-NX3J2 2700 1800 2300 3550 ASMT-UWB1-NX7B2 6500 2240 - 4500 ASMT-UWB1-NX7D2 5000 2240 - 4500	Part Number (K) Min Typ Max (mA) ASMT-UWB1-NX302 4500 ~ 8000 1800 2300 3550 20 ASMT-UWB1-NX312 2700 ~ 4000 1800 2300 3550 20 ASMT-UWB1-NX3A2 8000 1800 2300 3550 20 ASMT-UWB1-NX3B2 6500 1800 2300 3550 20 ASMT-UWB1-NX3C2 5700 1800 2300 3550 20 ASMT-UWB1-NX3D2 5000 1800 2300 3550 20 ASMT-UWB1-NX3F2 4500 1800 2300 3550 20 ASMT-UWB1-NX3G2 3500 1800 2300 3550 20 ASMT-UWB1-NX3H2 3000 1800 2300 3550 20 ASMT-UWB1-NX3J2 2700 1800 2300 3550 20 ASMT-UWB1-NX7B2 6500 2240 - 4500 20 ASMT-UWB1-NX7D2 5000 2240 - 45	

Notes:

- 1. The luminous intensity is measured at the mechanical axis of the lamp package. The actual peak of the spatial radiation pattern may not be aligned with this axis.
- 2. Tolerance ±12%

Part Numbering System



Absolute Maximum Ratings (T_A = 25°C)

Parameters	Rating
DC Forward Current (1)	30 mA
Peak Forward Current (2)	100 mA
Power Dissipation	108 mW
Junction Temperature	110° C
Operating Temperature	-40° C to +100° C
Storage Temperature	-40° C to +100° C

Notes

- 1. Derate linearly as shown in derating curve.
- 2. Duty Factor = 10%, Frequency = 1 kHz

Optical Characteristics ($T_A = 25^{\circ} C$)

		Dice		omaticity nates ⁽¹⁾	Viewing Angle $2\theta_{\frac{1}{2}}$ (Degrees)	Luminous Efficiency η_{e} (lm/W)	Total Flux / Luminous Intensity Θ_V (lm) / l $_V$ (cd)	CRI
Color	Part Number	Technology	X	у	Тур.	Typ.	Тур.	Min.
White	ASMT-UWB1	InGaN	0.33	0.34	120	100	2.8	70

Notes:

- 1. The chromaticity coordinates are derived from the CIE 1931Chromaticity diagram and represents the perceived color of the device.
- 2. $\theta_{1/2}$ is the off-axis angle where the luminous intensity is 1/2 the peak intensity.

Electrical Characteristics ($T_A = 25^{\circ}$ C)

		Forward Voltage V _F (Volts) @ I _F = 20 mA		Reverse Voltage V _R ⁽¹⁾ @ 10 μA	Thermal Resistance	
Color	Part Number	Min.	Max.	Min.	$R\theta_{J-P}$ (°C/W)	
White	ASMT-UWB1	2.8	3.6	5	150	

Note

1. Reverse Voltage indicates product final test condition. Long term reverse bias is not recommended.

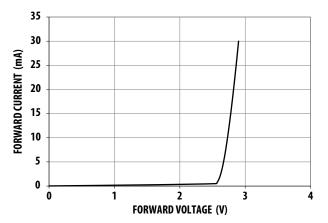


Figure 1. Forward current vs. forward voltage

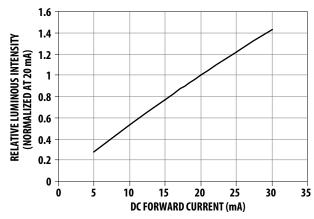


Figure 2. Relative intensity vs. forward current

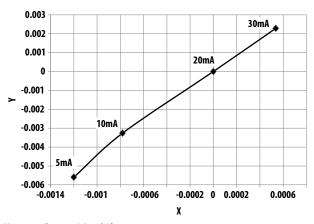


Figure 3. Chromaticity shift vs. current

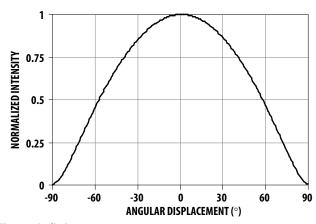


Figure 4. Radiation pattern

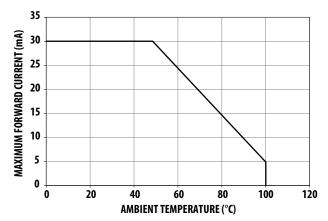


Figure 5. Maximum forward current vs. ambient temperature. Derated based on Tjmax 110° C, Rthja 600°C/W

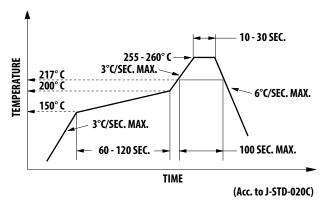
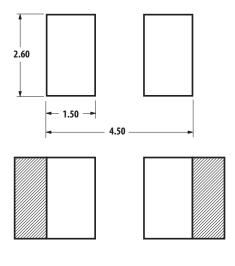


Figure 6. Recommended Pb-free reflow soldering profile



SOLDER RESIST

Figure 8. Recommended Soldering Pad Pattern

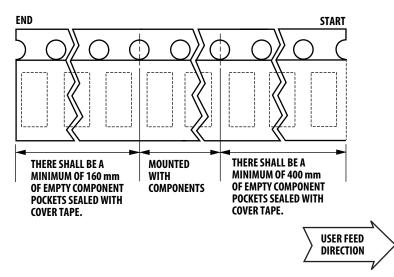


Figure 9. Tape Leader and Trailer Dimensions

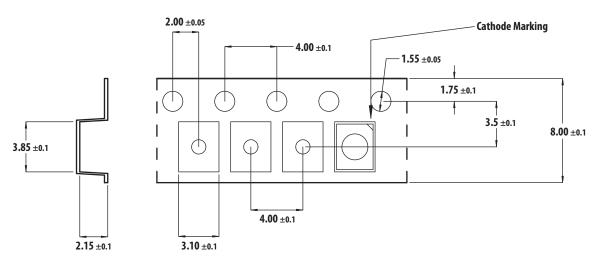


Figure 10. Tape Dimensions (Unit: mm)

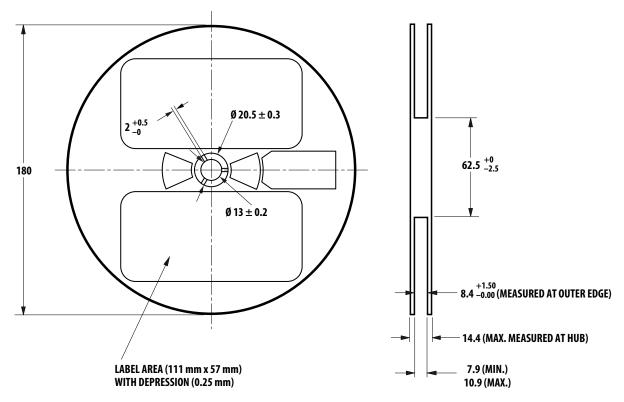


Figure 10. Reel Dimensions (Unit: mm)

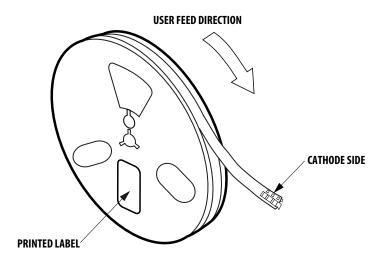


Figure 11. Reel Orientation

Intensity Bin Select (X₂ X₃)

Individual reel will contain parts from one half bin only.

X ₂	Min I _V Bin
Х3	
0	Full Distribution
3	3 half bins starting from x_21
4	4 half bins starting from x_21
5	5 half bins starting from x_21
7	3 half bins starting from x_2 2
8	4 half bins starting from x ₂ 2
9	5 half bins starting from x ₂ 2

Intensity Bin Limits

Bin ID	Min. (mcd)	Max. (mcd)
X1	1800	2240
X2	2240	2850
Y1	2850	3550
Y2	3550	4500
Z1	4500	5600
Z2	5600	7150
AA	2000	2500

Tolerance of each bin limit = $\pm 12\%$

Color Bin Selection (X₄)

Individual reel will contain parts from one full bin only.

X ₄	
Bin	Color Bin ID
Α	1A, 1B, 1C, 1D
В	2A, 2B, 2C, 2D
C	3A, 3B, 3C, 3D
D	4A, 4B, 4C, 4D
Е	5A, 5B, 5C, 5D
F	6A, 6B, 6C, 6D
G	7A, 7B, 7C, 7D
Н	8A, 8B, 8C, 8D
J	9A, 9B, 9C, 9D
K	1A, 1B, 1C, 1D, 2A, 2B, 2C, 2D,
L	2A, 2B, 2C, 2D, 3A, 3B, 3C, 3D
М	3A, 3B, 3C, 3D, 4A, 4B, 4C, 4D
N	4A, 4B, 4C, 4D, 5A, 5B, 5C, 5D
Q	6A, 6B, 6C, 6D, 7A, 7B, 7C, 7D
R	7A, 7B, 7C, 7D, 8A, 8B, 8C, 8D
S	8A, 8B, 8C, 8D, 9A, 9B, 9C, 9D
0	1A, 1B, 1C, 1D, 2A, 2B, 2C, 2D, 3A, 3B, 3C, 3D, 4A, 4B, 4C, 4D, 5A, 5B, 5C, 5D
1	6A, 6B, 6C, 6D, 7A, 7B, 7C, 7D, 8A, 8B, 8C, 8D, 9A, 9B, 9C, 9D

Color Bin ID Limits

Color Bin ID	Chro	maticity Coo	rdinates Limi	ts	
1A	х	0.2950	0.2920	0.2984	0.3009
	У	0.2970	0.3060	0.3133	0.3042
1B	Х	0.2920	0.2895	0.2962	0.2984
	у	0.3060	0.3135	0.3220	0.3133
1C	Х	0.2984	0.2962	0.3028	0.3048
	у	0.3133	0.3220	0.3304	0.3207
1D	х	0.2984	0.3048	0.3068	0.3009
	У	0.3133	0.3207	0.3113	0.3042
2A	х	0.3048	0.3130	0.3144	0.3068
	У	0.3207	0.3290	0.3186	0.3113
2B	Х	0.3028	0.3115	0.3130	0.3048
	У	0.3304	0.3391	0.3290	0.3207
2C	Х	0.3115	0.3205	0.3213	0.3130
	У	0.3391	0.3481	0.3373	0.3290
2D	Х	0.3130	0.3213	0.3221	0.3144
	у	0.3290	0.3373	0.3261	0.3186
3A	Х	0.3215	0.3290	0.3290	0.3222
	у	0.3350	0.3417	0.3300	0.3243
3B	Х	0.3207	0.3290	0.3290	0.3215
	у	0.3462	0.3538	0.3417	0.3350
3C	Х	0.3290	0.3376	0.3371	0.3290
	у	0.3538	0.3616	0.3490	0.3417
3D	Х	0.3290	0.3371	0.3366	0.3290
	у	0.3417	0.3490	0.3369	0.3300
4A	Х	0.3371	0.3451	0.3440	0.3366
	у	0.3490	0.3554	0.3427	0.3369
4B	Х	0.3376	0.3463	0.3451	0.3371
	у	0.3616	0.3687	0.3554	0.3490
4C	Х	0.3463	0.3551	0.3533	0.3451
	У	0.3687	0.3760	0.3620	0.3554
4D	Х	0.3451	0.3533	0.3515	0.3440
	У	0.3554	0.3620	0.3487	0.3427
5A	Х	0.3530	0.3615	0.3590	0.3512
	у	0.3597	0.3659	0.3521	0.3465
5B	Х	0.3548	0.3641	0.3615	0.3530
	у	0.3736	0.3804	0.3659	0.3597
5C	Х	0.3641	0.3736	0.3702	0.3615
	у	0.3804	0.3874	0.3722	0.3659
5D	Х	0.3615	0.3702	0.3670	0.3590
	у	0.3659	0.3722	0.3578	0.3521

Tolerance of each bin limit = ± 0.01

Color Bin ID	Chrom	naticity Coord	inates Limits		
6A	Х	0.3670	0.3702	0.3825	0.3783
	у	0.3578	0.3722	0.3798	0.3646
6B	Х	0.3702	0.3736	0.3869	0.3825
	у	0.3722	0.3874	0.3958	0.3798
6C	Х	0.3825	0.3869	0.4006	0.3950
	у	0.3798	0.3958	0.4044	0.3875
6D	х	0.3783	0.3825	0.3950	0.3898
	у	0.3646	0.3798	0.3875	0.3716
7A	Х	0.3889	0.3941	0.4080	0.4017
	у	0.3690	0.3848	0.3916	0.3751
7B	Х	0.3941	0.3996	0.4146	0.4080
	у	0.3848	0.4015	0.4089	0.3916
7C	х	0.4080	0.4146	0.4299	0.4221
	у	0.3916	0.4089	0.4165	0.3984
7D	Х	0.4017	0.4080	0.4221	0.4147
	у	0.3751	0.3916	0.3984	0.3814
8A	х	0.4147	0.4221	0.4342	0.4259
	у	0.3814	0.3984	0.4028	0.3853
8B	х	0.4221	0.4299	0.4430	0.4342
	у	0.3984	0.4165	0.4212	0.4028
8C	Х	0.4342	0.4430	0.4562	0.4465
	у	0.4028	0.4212	0.4260	0.4071
8D	х	0.4259	0.4342	0.4465	0.4373
	у	0.3853	0.4028	0.4071	0.3893
9A	х	0.4373	0.4465	0.4582	0.4483
	у	0.3893	0.4071	0.4099	0.3919
9B	Х	0.4465	0.4562	0.4687	0.4582
	у	0.4071	0.4260	0.4289	0.4099
9C	х	0.4582	0.4687	0.4813	0.4700
	У	0.4099	0.4289	0.4319	0.4126
9D	Х	0.4483	0.4582	0.4700	0.4593
	у	0.3919	0.4099	0.4126	0.3944

Tolerance of each bin limit = ± 0.01

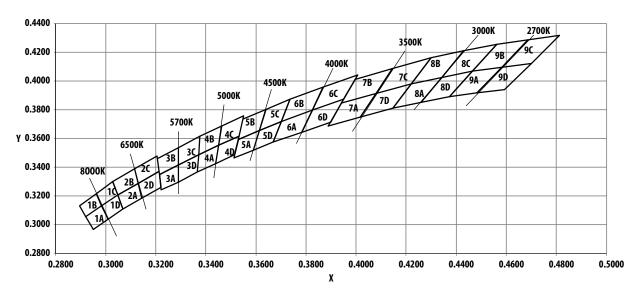


Figure 11. Color Bins

Packaging Option (X₅)

Option	Test Current	Package Type	Reel Size
2	20 mA	Top Mount	7 Inch

Forward Voltage Bin

Bin ID	Min.	Max
F03	2.4	2.6
F04	2.6	2.8
F05	2.8	3.0
F06	3.0	3.2

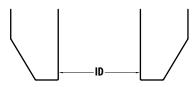
Tolerance of each bin limit = $\pm 0.1 \text{ V}$

PRECAUTIONARY NOTES

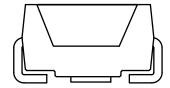
1. Handling precautions

The encapsulation material of the LED is made of silicone for better product reliability. Compared to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Special handling precautions need to be observed during assembly of silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED. Do refer to Application Note AN5288, Silicone Encapsulation for LED: Advantages and Handling Precautions for more information.

- a. Do not poke sharp objects into the silicone encapsulant. Sharp object like tweezers or syringes might apply excessive force or even pierce through the silicone and induce failures to the LED die or wire bond.
- b. Do not touch the silicone encapsulant. Uncontrolled force acting on the silicone encapsulant might result in excessive stress on the wire bond. The LED should only be held by the body.
- c. Do no stack assembled PCBs together. Use an appropriate rack to hold the PCBs.
- d. Surface of silicone material attracts dusk and dirt easier than epoxy due to its surface tackiness. To remove foreign particles on the surface of silicone, a cotton bud can be used with isopropyl alcohol (IPA). During cleaning, rub the surface gently without putting much pressure on the silicone. Ultrasonic cleaning is not recommended.
- e. For automated pick and place, Avago has tested nozzle size below to be working fine with this LED. However, due to the possibility of variations in other parameters such as pick and place machine maker/model and other settings of the machine, customer is recommended to verify the nozzle selected will not cause damage to the LED.



Note: Diameter "ID" should be bigger than 2.3mm



2. Handling of moisture sensitive device

This product has a Moisture Sensitive Level 3 rating per JEDEC J-STD-020. Refer to Avago Application Note AN5305, Handling of Moisture Sensitive Surface Mount Devices, for additional details and a review of proper handling procedures.

a. Before use

- An unopened moisture barrier bag (MBB) can be stored at <40°C/90%RH for 12 months. If the actual shelf life has exceeded 12 months and the humidity Indicator Card (HIC) indicates that baking is not required, then it is safe to reflow the LEDs per the original MSL rating.
- It is recommended that the MBB not be opened prior to assembly (e.g. for IQC).

b. Control after opening the MBB

- The humidity indicator card (HIC) shall be read immediately upon opening of MBB.
- The LEDs must be kept at <30°C / 60%RH at all times and all high temperature related processes including soldering, curing or rework need to be completed within 168 hours.

c. Control for unfinished reel

 Unused LEDs must be stored in a sealed MBB with desiccant or desiccator at <5%RH.

d. Control of assembled boards

 If the PCB soldered with the LEDs is to be subjected to other high temperature processes, the PCB need to be stored in sealed MBB with desiccant or desiccator at <5%RH to ensure that all LEDs have not exceeded their floor life of 168 hours.

e. Baking is required if:

- The HIC indicator is not BROWN at 10% and is AZURE at 5%.
- The LEDs are exposed to condition of $>30^{\circ}\text{C}$ / 60% RH at any time.
- The LED floor life exceeded 168hrs.

The recommended baking condition is: 60±5°C for 20hrs

Baking should only be done once.

f. Storage

The soldering terminals of these Avago LEDs are silver plated. If the LEDs are being exposed in ambient environment for too long, the silver plating might be oxidized and thus affecting its solderability performance. As such, unused LEDs must be kept in sealed MBB with desiccant or in desiccator at <5%RH.</p>

3. Application precautions

- a. Drive current of the LED must not exceed the maximum allowable limit across temperature as stated in the datasheet. Constant current driving is recommended to ensure consistent performance.
- b. LED is not intended for reverse bias. Do use other appropriate components for such purpose. When driving the LED in matrix form, it is crucial to ensure that the reverse bias voltage is not exceeding the allowable limit of the LED.
- c. Do not use the LED in the vicinity of material with sulfur content, in environment of high gaseous sulfur compound and corrosive elements. Examples of material that may contain sulfur are rubber gasket, RTV (room temperature vulcanizing) silicone rubber, rubber gloves etc. Prolonged exposure to such environment may affect the optical characteristics and product life.
- d. Avoid rapid change in ambient temperature especially in high humidity environment as this will cause condensation on the LED.
- e. Although the LED is rated as IPx6 and IPx8 according to IEC60529: Degree of protection provided by enclosure, the test condition may not represent actual exposure during application. If the LED is intended to be used in outdoor or harsh environment, the LED must be protected against damages caused by rain water, water,dust, oil, corrosive gases, external mechanical stress etc.

4. Thermal management

Optical, electrical and reliability characteristics of LED are affected by temperature. The junction temperature (T_J) of the LED must be kept below allowable limit at all times. T_I can be calculated as below:

 $T_J = T_A + R_{\theta J-A} \times I_F \times V_{Fmax}$

where;

 T_A = ambient temperature [°C]

 $R_{\theta J\text{-}A} =$ thermal resistance from LED junction to ambient $\lceil ^{\circ} C/W \rceil$

 $I_F = forward current [A]$

 V_{Fmax} = maximum forward voltage [V]

The complication of using this formula lies in T_A and $R_{\theta J-A}$. Actual T_A is sometimes subjective and hard to determine. $R_{\theta J-A}$ varies from system to system depending on design and is usually not known.

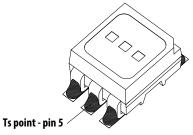
Another way of calculating T_J is by using solder point temperature T_S as shown below:

$$T_J = T_S + R_{\theta J-S} \times I_F \times V_{Fmax}$$

where;

 T_S = LED solder point temperature as shown in illustration below [°C]

 $R_{\theta J\text{-}S}$ = thermal resistance from junction to solder point [°C/W]



 T_S can be measured easily by mounting a thermocouple on the soldering joint as shown in illustration above, while $R_{\theta J-S}$ is provided in the datasheet. User is advised to verify the T_S of the LED in the final product to ensure that the LEDs are operated within all maximum ratings stated in the datasheet.

5. Eye safety precautions

LEDs may pose optical hazards when in operation. It is not advisable to view directly at operating LEDs as it may be harmful to the eyes. For safety reasons, use appropriate shielding or personal protective equipments.

6. Disclaimer

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Contact Us:

> Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

> Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

Customer Service :

Email service@ameya360.com

Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com